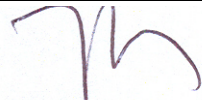




Contact Date:	Implementation Date:	Alert Category:	Alert Type:	PCN #:
May 23, 2008	June 21, 2008	Discrete Semiconductor	Bond Wire Change	PCN #: 1111
TITLE				
COPPER BOND WIRE IMPLEMENTATION				
IMPACT				
None				
DESCRIPTION OF CHANGE				
Improve selected electrical and mechanical properties by changing from gold to copper bond wire.				
PRODUCTS AFFECTED				
2N7002A-7, DMN66D0LDW-7, DMN3150L-7, DMP2130LDM-7, DMP2215L-7, DMN3033LSN-7				
WEB LINKS				
Manufacturer's Notice:	http://www.diodes.com/products/PCNs.shtml			
For More Information Contact:	http://www.diodes.com/contact			
Data Sheet:	http://www.diodes.com/index.php			
DISCLAIMER				
Unless a Diodes Inc. Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.				
PCN APPROVAL				
Signatories	Name	Signature	Date	
Signature of Sr. Vice President, Sales & Mktg.	Mark King		23 May 2008	
Signature of VP Corporate Administration	Ed Tang		23 May 2008	
Signature of VP Product Development	Francis Tang		23 May 2008	



PCN-1111_Rev 00
Part Number Listing

Part Number
2N7002A-7
DMN66D0LDW-7
DMN3150L-7
DMP2130LDM-7
DMP2215L-7
DMN3033LSN-7